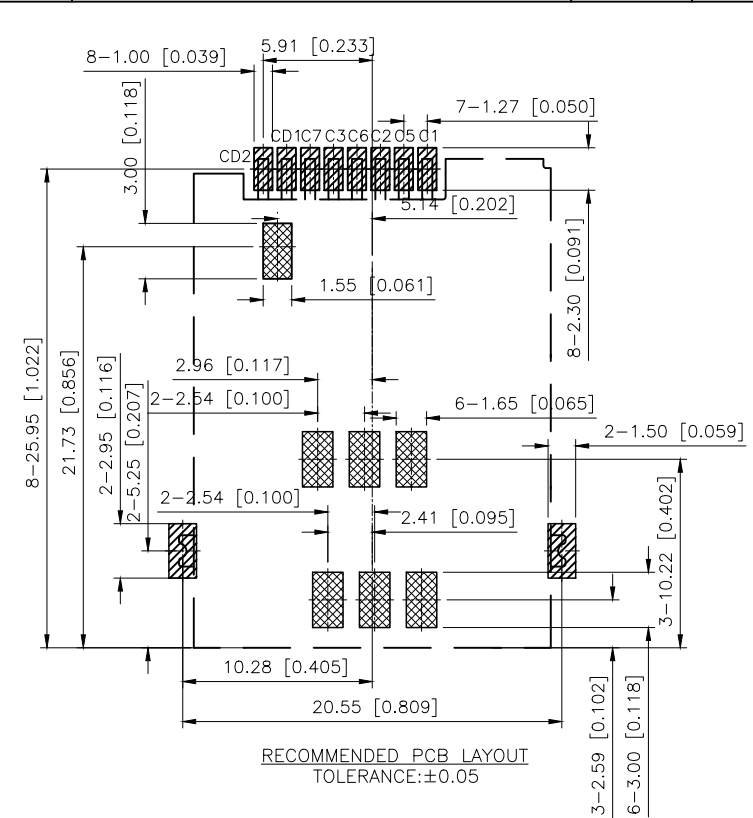
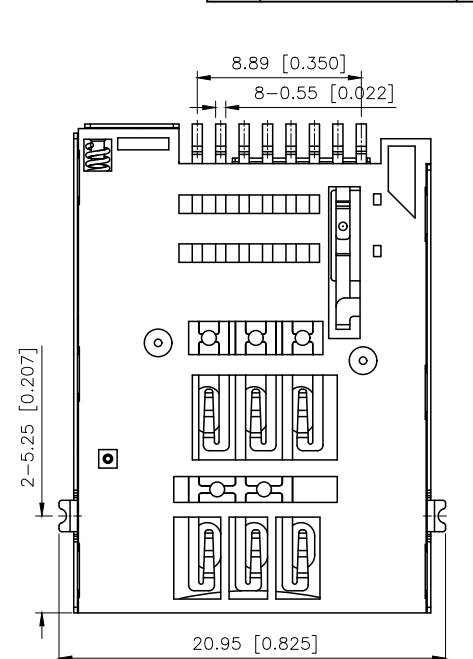
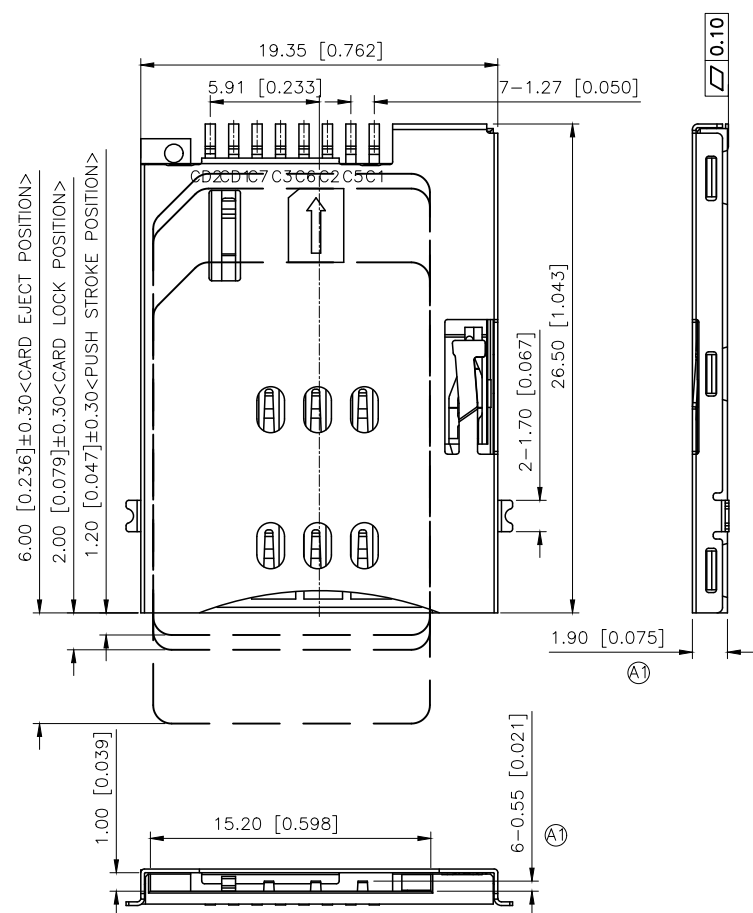


REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	/	/
A1	N/A	A1 X2	尺寸变更, 图面升级整理图面	2025.05.14	阿树



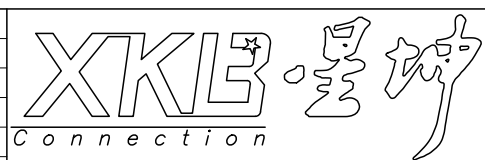
RECOMMENDED PCB LAYOUT
TOLERANCE: ±0.05

- SMT SOLDER AREA
- COPPER RESTRICTED AREA
- 1.TOUCH AREA OF CONTACT
- TIPS NO ELECTRICAL FUNCTION
- 2.NO FIRST PCB_LAYOUT
- CIRCUITS IN THE AREA

Notes:

- Material:
Housing: High Temperature Thermoplastic
Terminal: Copper Alloy
Shell: Stainless Steel
- Plating:
Terminal: 50u" Ni Underplated Overall
G/F Plated On Contact Area
Matte Tin Plated On Solder Area
Shell: 30u" Ni Underplated Overall
G/F Plated On Contact Area And Solder Area
- Technical Specialty:
Rated Voltage: 30V
Current Rating: 0.5A
Insulation Resistance: 1000MΩ Min.
Contact Resistance: 100mΩ Max.
Withstanding Voltage: 500V DC For 1 Minutes.
Operating Temperature: -40 ~ +85 °C
Humidity 80% R.H Max.

AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERANCES	



DESIGN	阿树	VIEW:	MODEL TYPE:
CHECKED		UNIT: mm/in	PART NO.:
APPROVED		SIZE: A4	DWG NO.:

PIN/NO	ASSIGNMENT
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O
CD1	POL
CD2	Detect Switch

